TOSHIBA Bipolar Linear Integrated Circuit Silicon Monolithic

TA8127NG, TA8127FG

3V AM / FM 1chip Tuner IC

TA8127NG and TA8127FG are the AM / FM 1chip tuner ICs, which are designed for portable radios and 3V headphone radios.

Features

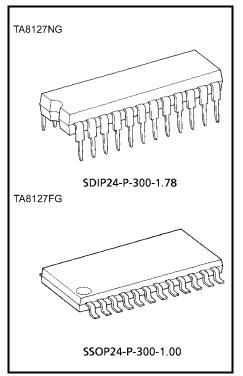
• Built-in

FM F / E, AM / FM IF and FM MPX

- AM detector coil and IF coupling condenser are not needed.
- Compact package

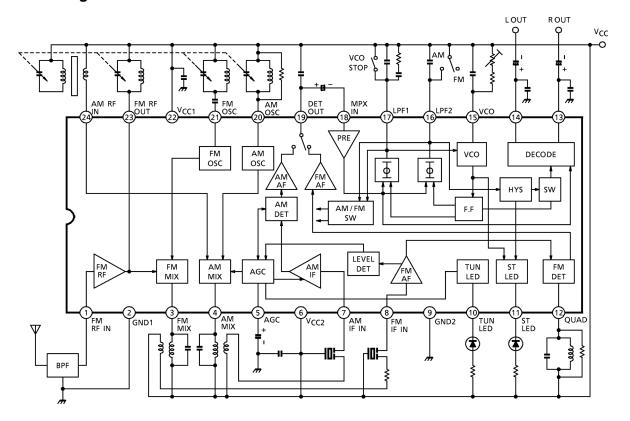
TA8127NG: Shrink DIP 24 pin (1.78mm pitch) TA8127FG: Mini flat packge 24 pin

• Operating supply voltage range $V_{CC} = 1.8{\sim}7.0V \ (Ta = 25{\circ}C)$



Weight SDIP24-P-300-1.78: 1.2g (typ.) SSOP24-P-300-1.00: 0.31 (typ.)

Block Diagram



Explanation Of Terminals

Pin No.	Item	Internal Circuit	DC Voltage (V) (at no Signal)		
			AM	FM	
1	FM-RF IN	FM-RF OUT (23) 1 1 1 1 1 1 1 1 1 1 1 1 1	0	0.7	
2	GND1 (GND for RF stage)	_	0	0	
3	FM MIX	Vcc1 ②	3.0	3.0	
4	AM MIX	V _{CC1} 22 Mix GND1 2	3.0	3.0	
5	AGC (AM AGC)	S AGC AGC S	0	0	
6	V _{CC2} (V _{CC} for IF / MPX stage)	-	3.0	3.0	
7	AM IF IN	VCC2 6 CF F F F F F F F F F F F F F F F F F	3.0	3.0	
8	FM IF IN	V _{CC2} 6	3.0	3.0	

Pin No.	Item	Internal Circuit	DC Voltage (V) (at no Signal)		
			AM	FM	
9	GND2 (GND for IF / MPX stage)	_	0	0	
10	TUN LED (tuning LED)	V _{CC2} 6 10 10 GND2 9	_	_	
11	ST LED (stereo LED)	76kHz ————————————————————————————————————	ı	_	
12	QUAD (FM QUAD. Detector)	VCC2 6	3.0	3.0	
13 14	R-OUT (R-ch output) L-OUT (L-ch output)	V _{CC2} 6 GND2 9 GND2	1.0	1.0	
15	VCO	VCC2 6 AMP 15 GND2 9	2.5	2.5 (VCO stop mode)	
16	LPF2 • LPF terminal for synchronous detector • Bias terminal for AM / FM SW circuit $V_{16} = V_{CC} \rightarrow AM (VCO stop)$ $V_{16} = OPEN \rightarrow FM$	GND2 9	3.0	2.2 (VCO stop mode 2.7)	
17	LPF1 • LPF terminal for phase detector • VCO stop terminal V ₇ = V _{CC} →VCO stop	GND2 9	2.7	2.2	

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Pin No.	Item	Internal Circuit	DC Voltage (V) (at no Signal)		
			AM	FM	
18	MPX IN	(B) (S) (S) (S) (S) (S) (S) (S) (S) (S) (S	0.7	0.7	
19	DET OUT	VCC2 6 AM O FM O B B COM B COM B COM COM COM	1.5	1.2	
20	AM OSC	V _{CC1} 22 MIX GND1 2	3.0	3.0	
21	FM OSC	V _{CC1} (2) (2) MIX (3) GND1 (2)	3.0	3.0	
22	V _{CC1} (V _{CC} for RF stage)	_	3.0	3.0	
23	FM RF OUT	Cf. Pin(1)	3.0	3.0	
24	AM RF IN	V _{CC1} 22 24 GND1 2	3.0	3.0	

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Maximum Ratings (Ta = 25°C)

Characteris	stic	Symbol	Rating	Unit	
Supply voltage		V _{CC}	8	V	
LED current		I _{LED}	10	mA	
LED voltage		V_{LED}	8	V	
Power dissipation	TA8127NG	P_{D}	1200	mW	
rower dissipation	TA8127FG	(Note)	400	IIIVV	
Operating temperature		T _{opr}	-25~75	°C	
Storage temperature		T _{stg}	-55~150	°C	

Note: Derated above 25°C in the proportion of 9.6mW / °C for TA8127NG and of 3.2mW / °C for TA8127FG.

Electrical Characteristics

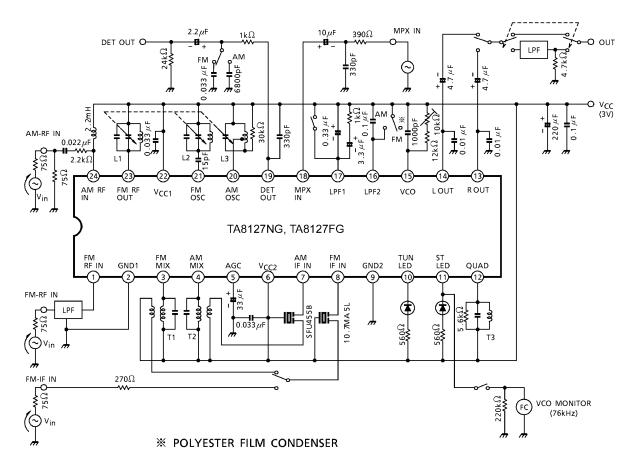
Unless Otherwise Specified,

Ta = 25°C, V_{CC} = 3V, F / E: f = 83MHz, f_m = 1kHz FM IF: f = 10.7MHz, Δf = ±22.5kHz, f_m = 1kHz AM: f = 1MHz, MOD = 30%, f_m = 1kHz MPX: f_m = 1kHz

Characteristic		Symbol	Test Cir– cuit	Test Condition	Min.	Тур.	Max.	Unit
Sunn	ly current	I _{CC (FM)}	1	V _{in} = 0, FM mode	_	13.2	20.0	mA
Supp	y current	I _{CC (AM)}	1	V _{in} = 0, AM mode	_	8.4	13.5	IIIA
F/E	Input limiting voltage	Vin (lim.)	1	– 3dB limiting	_	10.0	_	dBµV EMF
F / E	Local OSC voltage	Vosc	2	f _{OSC} = 72.3MHz	_	105	_	mV _{rms}
	Input limiting voltage	V _{in (lim.)} IF	1	– 3dB limiting	40	46	53	dBµV EMF
	Rcovered output voltage V _{OD}		1	V _{in} = 80dBµV EMF	55	80	110	mV _{rms}
FM IF	Signal to noise ratio	S/N	1	V _{in} = 80dBμV EMF	_	70	_	dB
II-	Total harmonic distortion	THD	1	V _{in} = 80dBμV EMF	_	0.4	_	%
	AM rejection ratio	M rejection ratio AMR		V _{in} = 80dBμV EMF	_	32	_	dB
	Lamp on sensitivity	VL	1	I _L = 1mA	45	51	56	dBµV EMF
	Gain	G _V	1	V _{in} = 26dBμV EMF	40	70	110	m\/
	Recovered output voltage	V _{OD}	1	V _{in} = 60dBμV EMF	55	80	110	mV _{rms}
AM	Signal to noise ratio	S/N	1	V _{in} = 60dBμV EMF	_	42	_	dB
	Total harmonic distortion	THD	1	V _{in} = 60dBμV EMF	_	1.0	_	%
	Lamp on sensitivity	VL	1	I _L = 1mA	20	25	30	dBµV EMF
Din/1	9) output resistance	D.,	1	FM mode	_	0.75	_	kΩ
-III(I	a) output resistance	R ₁₉	'	AM mode	_	12.5	_	K12

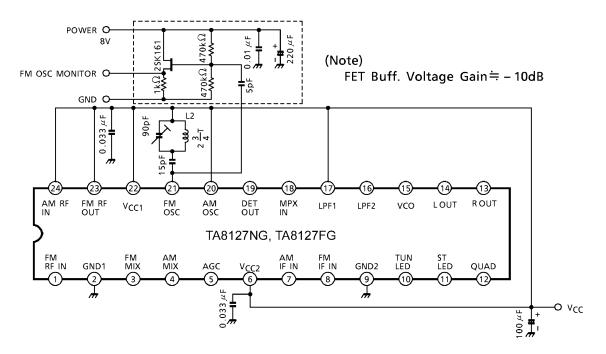
Characteristic		Symbol	Test Cir– cuit	Test Condition		Min.	Тур.	Max.	Unit			
	Input resistan	ce	R _{IN}	_	-	_	_	24	_	1.0		
	Output resista	nce	R _{OUT}	_	-		_	5	_	kΩ		
	Max. Compos signal input vo		V _{in (max.)} stereo	1			L+R = 90%, P = 10% f _m = 1kHz, THD = 3%		_	350	_	mV _{rms}
					L+R =	f _m = 100Hz	_	42	_			
	Separation		Sep	1	135mV _{rms}	f _m = 1kHz	35	42	-	dB		
					P = 15mV _{rms}	f _m = 10kHz	_	42				
	Total harmonic	Monaural	THD (monaural)	1	V _{in} = 150mV _{rm}	— 0.2		_	%			
MPX	distortion	Stereo	THD (stereo)	1	L+R = 135mV _m P = 15mV _{rms}	ms,	_	0.2		%		
	Voltage gain		G _{V (MPX)}	1	V _{in} = 150mV _{rms}		-5	-3	-1	dB		
	Channel balar	nce	C. B.	1	V _{in} = 150mV _{rms}		-2	0	2	uБ		
	Stereo lamp	On	V _{L (ON)}	1	Pilot input		_	8	16	m\/		
	sensitivity	Off	V _{L (OFF)}] '	Pilot input	Pilot input		6	-	mV _{rms}		
	Stereo lamp hysteresis		V _H	1	To LED turn off from LED turn on		_	2	_	mV _{rms}		
	Caputure range		C. R.	1	P = 15mV _{rms}		_	±3	_	%		
	Signal to noise ratio		S/N	1	V _{in} = 150mV _{rm}	S	_	70		dB		

Test Circuit 1



Using other types of condensers, there are some cases that the MPX does not do normal stereo action at high temperature or low temperature.

Test Circuit 2



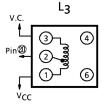
Coil Data

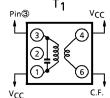
Coil No.	Test	L	Co	0.5			Turns			Wire	Reference
Coll No.	Freq. (Hz)	(µH)	(pF)	QO	1–2	2–3	1–3	1–4	4–6	(mmφ)	Reference
L ₁ FM RF	100M	_		100	l	_	_	$2\frac{1}{2}$	_	0.5UEW	(S) 53T-037-202
L ₂ FM OSC	100M	_		100		_	$2\frac{3}{4}$	_	_	0.5UEW	(S) 0258–244
L ₃ AM OSC	796k	288	_	115	13	73	_	_	_	0.08UEW	(S) 4147-1356-038
T ₁ FM MIX	10.7M	_	75	100	_	_	13	_	2	0.1UEW	(S) 2153-414-041
T ₂ AM MIX	455k	_	180	120	_	_	180	_	15	0.08UEW	(S) 2150-2162-165
T ₃ FM DET	10.7M	_	47	165	_	_	16	_	_	0.09UEW	(S) 2153-4095-122

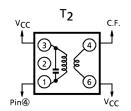
(S): SUMIDA electric CO., LTD











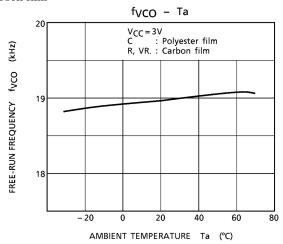


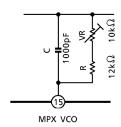
Hint On Use Of TA8127NG And TA8127FG

External parts of MPX VCO

(1) Temperature characteristic of MPX VCO free –run frequency. The temperature characteristic of MPX VCO is shown in the diagram as below. Select one with a better temperature characteristic (C, R and VR.) in use. We recommend,

C : Polyester film R, VR: Carbon film





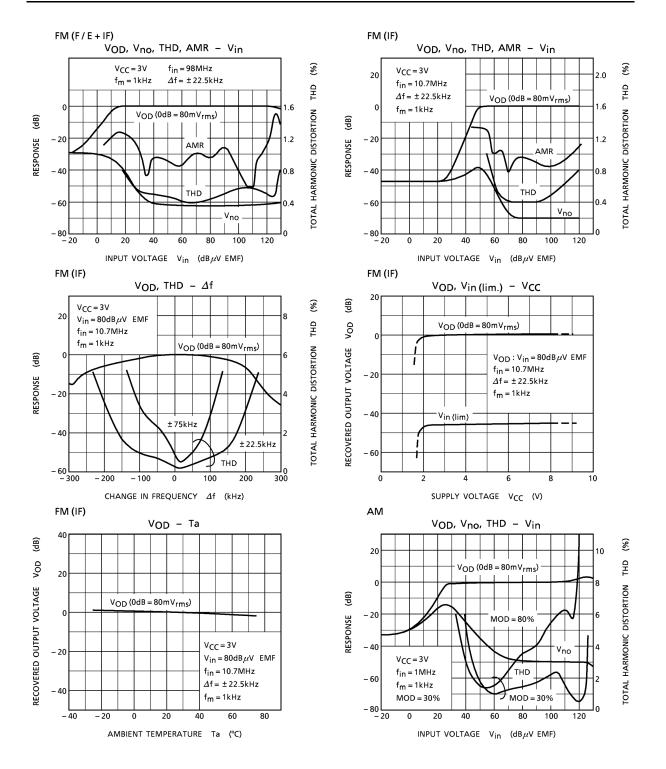
(2) Value of the external parts

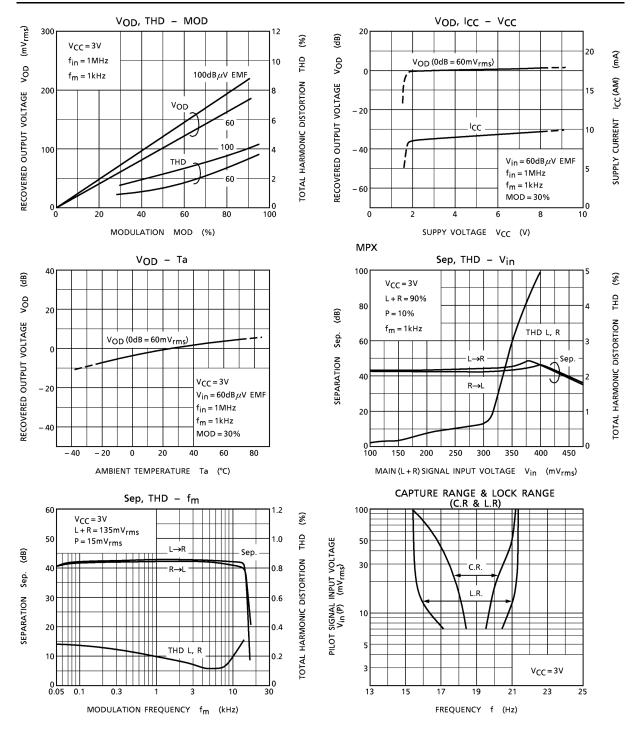
We recommend to set up these value as below.

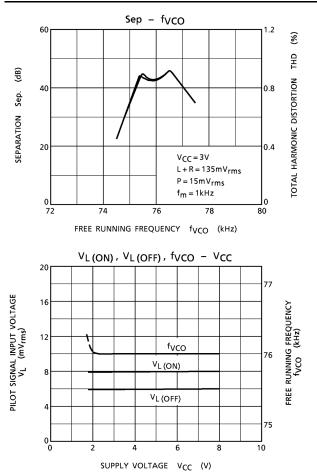
 $\mathrm{R}=12\mathrm{k}\Omega$

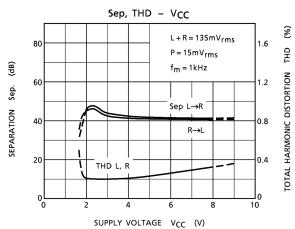
 $\mathrm{VR}=10\mathrm{k}\Omega$

C = 1000pF





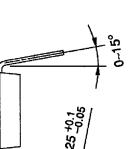


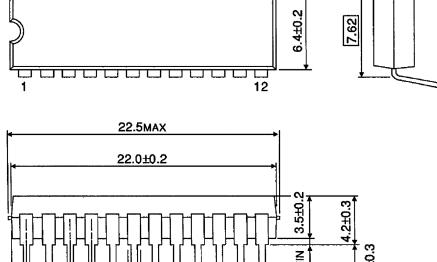


Unit: mm

Package Dimensions

SDIP24-P-300-1.78





0.46±0.1

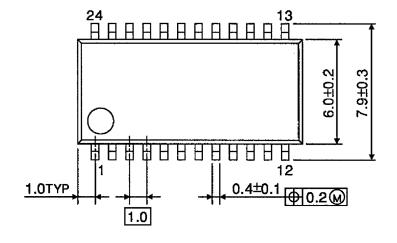
Weight: 1.2g (typ.)

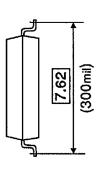
1.778

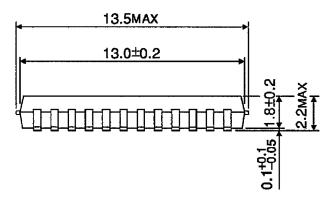
1.221TYP

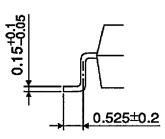
Package Dimensions

SSOP24-P-300-1.00 Unit: mm









Weight: 0.31g (typ.)

About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-63Pb solder Bath
 - solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

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